



## Statement of Compliance

### Requested Part

30 November 2011

1-640518-0


( Part 12 of 12)

03P MR II PLUG HSG V0 RED

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Wave solder capable to 240°C

China RoHS:  No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Contains no REACH October 2008 SvHC(s)

REACH Jan/Mar 2010 SvHC Compliance: Contains no REACH Jan/Mar 2010 SvHC(s)

REACH June 2010 SvHC Compliance: Contains no REACH June 2010 SvHC(s)

REACH Dec 2010 SvHC Compliance: Contains no REACH December 2010 SvHC(s)

REACH June 2011 SvHC Compliance: Not reviewed for REACH June 2011 SvHC(s)

Halogen Content: Not Yet Reviewed for halogen content

David R. Bender

Director, Product Compliance

---

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as TE cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.